Cover Letter-Modular Approval

FCC ID: BEJRBHP-B213A Date: 11 January, 2018

Gentlemen:

Company

There's a Bluetooth Module that would like to have your authorization as a modular approval. The specific product as below, Bluetooth Module, with its designed features and specified description, meets special requirements for full modular approval on Requirement of RSP-100 issue 10 Section 7.3 by cross-reference list below.

LG Electronics Inc.

Model Name	Bluetooth Module		
Model Number	RBHP-B213A		
FCC ID	BEJRBHP-B213A		
		Comply (Y/N)
a)The radio elements shall have the radio frequency circuitry shielded. Physical / discrete and tuning capacitors may be located external to the shield, but must be on the module assembly.		Y	
b)The module shall have buffered modulation/data input(s) (if such inputs are provided) to ensure that the module will comply with the requirements set out in the applicable RSS standard under conditions of excessive data rates or overmodulation.		Y	
c)The module shall have its own power supply regulation on the module. This is to ensure that the module will comply with the requirements set out in the applicable standard regardless of the design of the power supplying circuitry in the host device which houses the module.		Y	
d)The module shall comply with the provisions for external power amplifiers and antennas detailed in the applicable RSS standard. The equipment certification submission shall contain a detailed description of the configuration of all antennas that will be used with the module.		Y	
e) The module shall be tested for compliance with the applicable standard in a stand-alone configuration, i.e. the module must not be inside another device during testing.		Y	
f) The module shall comply with the Category I equipment labelling requirements.		Y	
g) The module shall comply with applicable RSS-102 exposure requirements, which are based on the intended use/configurations.		Y	

h)Is the modular device for an Industry	Canada Y
licence-exempt service?	
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Thank you.	
Sincerely,	
Lyun Geng Kin	II C II.
By: (Signature ¹)	Hyun Seung, Kim
(Signature)	(Print name)
Title: Research Engineer	
On behalf of: LG Electronics Inc.	
On behalf of: LG Electronics Inc. (Company Name)	
(Company Name)	

Telephone: $\pm 82 - 10 - 2743 - 4708$